No.: RPCH-K-HTS-0002/2

Date: 2024.12.13

Data sheet

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR

TYPE AND HIGH POWER · ANTI SURGE

Style: RPCH10,16,20,32,35

AEC-Q200 qualified

RoHS COMPLIANCE ITEM Halogen and Antimony Free

Note: • Stock conditions

Temperature: $+5^{\circ}\text{C} \sim +35^{\circ}\text{C}$ Relative humidity: $25\% \sim 75\%$

The period of guarantee: Within 2 year from shipment by the company.

Solderability shall be satisfied.

- Product specification contained in this data sheet are subject to change at any time without notice
- If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff.



Hokkaido Research Center Approval by: T. Sannomiya Drawing by: M. Shibuya

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1. Scope

1.1 This data sheet covers the detail requirements for fixed thick film chip resistors; rectangular type & high power · anti surge, style of RPCH10,16,20,32,35.

Style

1.2 Applicable documents

JIS C 5201-1: 2011, IEC60115-1: 2008, AEC-Q200 Rev.D

2. Classification

Type designation shall be the following form.

(Example)

RPCH	32	K	123	J	TP
1	2	3	4	5	6
Style	9				

- 1 Fixed thick film chip resistors; rectangular type & & high power · anti surge
- 2 Rated dissipation and / or dimension
- 3 Temperature coefficient of resistance

K	±100×10 ⁻⁶ / °C
-(Dash)	Standard

4 Rated resistance

123	E24 Series, 3 digit,	Ex. 123> 12kΩ,
1000	E96 Series, 4 digit,	Ex. 1000>100Ω
		1022> 10.2kΩ

5 Tolerance on rated resistance

D	±0.5%
F	±1%
J	±5%

6 Packaging form

TH	Donor toning	
TP	Paper taping	
TE	Embossed taping	

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3. Rating

3.1 The ratings shall be in accordance with Table-1.

Table-1

Style	Rated dissipation (W)		ure coefficient of nce (10°/°C)	Rated resistance range (Ω)	Preferred number series for resistors	Tolerance on rated resistance
		K	±100	10~1M	E24, 96	D(±0.5%)
RPCH10	0.2	Standard	±200	1.0~9.76	⊑24, 90	F(±1%)
KECHIO	0.2	K	±100	10~1M	E24	1/150/)
		Standard	±200	1.0~9.1	E2 4	J(±5%)
		K	±100	10~1M	E24, 96	D(±0.5%),
RPCH16	0.33	Standard	±200	1.0~9.76	⊑24, 90	F(±1%)
RECHIO	0.55	K	±100	10~1M	E24	J(±5%)
		Standard	±200	1.0~9.1		
		K	±100	10~1M	E24, 96	D(±0.5%),
RPCH20	0.5	Standard	±200	1.0~9.76	L24, 90	F(±1%)
IXF CI IZO	0.5	K	±100	10~1M	E24	J(±5%)
		Standard	±200	1.0~9.1	LZŦ	3(±376)
		K	±100	10~1M	E24, 96	D(±0.5%),
RPCH32	0.66	Standard	±200	1.0~9.76	L24, 30	F(±1%)
IXI OHIOZ	0.00	K	±100	10~1M	E24	J(±5%)
		Standard	±200	1.0~9.1		3(±370)
		K	±100	10~1M	E24, 96	D(±0.5%),
RPCH35	0.75	Standard	±200	1.0~9.76		F(±1%)
111 01 100	0.70	K	±100	10~1M		J(±5%)
		Standard	±200	1.0~9.1		J(±J /0)

Style	Limiting element voltage	Insulation voltage	Category temperature
Otylo	(V)	(V)	range(°C)
RPCH10	50	100	
RPCH16	150	150	
RPCH20			<i>–</i> 55∼+155
RPCH32	200	500	
RPCH35			

3.2 Derating

The derated values of dissipation at temperature in excess of 70 °C shall be as indicated by the following curve.

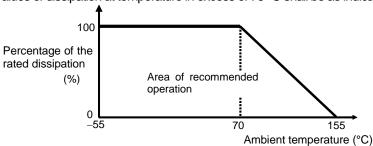


Figure-1 Derating curve

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3.3 Rated voltage

d.c.or a.c.r.m.s.voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

$$E = \sqrt{P \cdot R}$$

E: Rated voltage (V)

P: Rated dissipation (W)

R: Rated resistance (Ω)

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

4. Packaging form

The standard packaging form shall be in accordance with Table-2.

Table-2

Symbol	Packaging form		Standard packaging quantity / units	Application
TH	Donor toning	8mm width, 2mm pitches	10,000 pcs.	RPCH10
TP	Paper taping	8mm width, 4mm pitches	5,000 pcs.	RPCH16,20,32
TE	Embossed taping	8mm width, 4mm pitches	4,000 pcs.	RPCH35

5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-3.

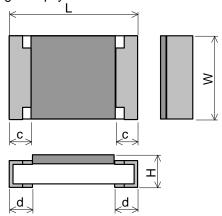


Figure-2

Table–3 Unit: mm

Style	L	W	Н	С	d
RPCH10	1.0±0.05	0.5±0.05	0.35±0.05	0.2±0.15	0.25 ^{+0.05} _{-0.10}
RPCH16	1.6±0.1	0.8 +0.15 -0.05	0.45±0.10	0.3±0.2	0.3±0.1
RPCH20	2.0±0.1	1.25±0.10	0.55±0.10	0.3±0.2	0.4±0.2
RPCH32	3.1±0.1	1.6±0.15	0.55±0.10	0.3±0.2	0.5±0.25
RPCH35	3.1±0.15	2.5±0.15	0.55±0.15	0.3±0.2	0.5±0.25

5.2 Net weight (Reference)

Style	Net weight(mg)
RPCH10	0.6
RPCH16	2
RPCH20	5
RPCH32	9
RPCH35	16

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6. Marking

The Rated resistance of RPCH10 is not be marked.

RPCH16,20,32,35

The Rated resistance shall be marked in 3 digits (E24) or 4 digits (E96) and marked on over coat side.

• E24 series: 3 digits, E96 series: 4 digits

In case of the resistance value that E96 overlaps with E24, It is marked by either.

• The Rated resistance of RPCH16 should not be marked in 4 digits(E96)

Marking example	Contents	Application
123	12x10 ³ $[\Omega] \rightarrow$ 12 $[k\Omega]$	E24(RPCH16,20,32,35)
2R2	2.2 [Ω]	E24(RPCH 16,20,32,35)
5623	$562 \times 10^3 [\Omega] \rightarrow 562 [k\Omega]$	E96(RPCH 20,32,35)
12R7	12.7 [Ω]	E96(RPCH 20,32,35)

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7. Performance

7.1 The standard condition for tests shall be in accordance with Sub-clause 4.2, JIS C 5201–1: 2011.

7.2 The performance shall be satisfied in Table-4.

Table-4(1)

	T + 12	1able-4(1)	D (
No.	Test items	Condition of test	Performance requirements
1	High temperature exposure	MIL-STD-202 Method 108	Δ R/R: Within \pm (2%+0.1 Ω)
	AEC Q200 - No.3	Ambient temperature:155±2°C,	
		Condition: Without load,	No visible damage
		Duration: 1000 ⁺⁴⁸ ₀ h	
		Interval measurements: 250 h and 500 h	
2	Temperature cycling	JESD22 Method JA-104	Δ R/R: Within \pm (1%+0.05 Ω)
	AEC Q200 - No.4	Temperature: -55±3°C / 125±2°C,	
		Dwell time: 30min maximum at each temp.	No visible damage
		Transition time: 1 min. max.	
		Number of cycles: 1000 cycles.	
		Interval measurements: 250 cy and 500 cy	
3	Bias humidity	MIL-STD-202 Method 103	Δ R/R: Within \pm (2%+0.1 Ω)
	AEC Q200 – No.7	Condition: 85°C & 85% R.H.	
		Test power: 10% of rated power shall be	No visible damage
		applied for continuously.	
		Duration: 1,000 $\frac{^{+48}}{^{0}}$ h	
		Interval measurements: 250 h and 500 h	
4	Operational life	MIL-STD-202 Method 108	Δ R/R: Within \pm (2%+0.1 Ω)
	AEC Q200 – No.8	Ambient temperature: 125±2°C	,
		The applied voltage shall be the voltage to be	No visible damage
		calculated at 35% of rated dissipation or the	
		limiting element voltage whichever is the	
		smaller.	
		Condition: The voltage shall be applied for continuously.	
		Duration: 1000 +48 h	
		Interval measurements: 250 h and 500 h	
5	External Visual	MIL-STD-883 Method 2009	Inspect device construction, marking
	AEC Q200 – No.9		and workmanship.
6	Dimensions	JESD22 Method JB-100	As in Table-3
	AEC Q200 – No.10		
7	Resistance to Solvents	MIL-STD-202 Method 215	Δ R/R: Within \pm (1%+0.05 Ω)
	AEC Q200 – No.12	Solvent: 2-propanol at 25°C	
		Immersion time: 3 min	No visible damage
		Brush: 10 times brushing	
	N	Immersion and brush cycle: 3cycle	
8	Mechanical Shock	MIL-STD-202 Method 213	Δ R/R: Within \pm (0.5%+0.05 Ω)
	AEC Q200 – No.13	Waveform: half sine,	
		Peak value100G,	No visible damage
		Normal duration 6ms	
		Condition: XX'YY'ZZ', 10times each	

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Table-4(2)

		1abic 4(2)		
No	Test items	Condition of test	Performance requirements	
9	Vibration AEC Q200 – No.14	MIL-STD-202 Method 204 Peak acceleration and Sweep time: 5 g's for	Δ R/R: Within $\pm (0.5\% + 0.05\Omega)$	
		20 min , Frequency 10Hz to 2000Hz, Condition: 12 cycles each of 3 orientations	No visible damage	
10	Resistance to soldering heat AEC Q200 - No.15	MIL-STD-202 Method 210 Solder bath temp: 260±5°C	Δ R/R: Within \pm (0.5%+0.05 Ω)	
		Immersed time: 10±1s	No visible damage	
11	ESD test AEC Q200 – No.17	AEC-Q200-002 Human body model, 2 Kohm, 150 pF, Test voltage: RPCH20,32,35: 3000V RPCH16: 2000V RPCH10: 800V	Δ R/R: Within \pm (1%+0.05 Ω) No visible damage	
12	Solderability AEC Q200 – No.18	J-STD-002 a) Bake the sample for 155 °C dwell time 4h / solder dipping 235°C/5s. Solder: Sn96.5-Ag3-Cu0.5 b) Category 3, Solder dipping 215°C/5s. Solder: Sn63Pb37 c) Category 3, Solder dipping 260°C/7s.	The surface of terminal immersed shall be min. of 95% covered with a new coating of solder.	
13	Electrical Characterization AEC Q200 - No.19	1. D.C. Resistance 2. Temperature Coefficient of Resistance -55 °C / +20 °C +20 °C / +155 °C	The resistance value shall correspond with the rated resistance taking into account the specified tolerance. As in Table–1	
14	Flammability AEC Q200 – No.20	UL-94	V-0 or V-1 are acceptable	
15	Bending strength AEC Q200 – No.21	AEC-Q200-005 Bending value2mm Holding time: 60sec.	Δ R/R: Within \pm (0.5%+0.05 Ω) No visible damage	
16	Adhesion AEC Q200 – No.22	AEC-Q200-006 Pressurizing force: RPCH20,32,35: 17.7N RPCH10,16: 10N Test time: 60±1s.	Δ R/R: Within $\pm (0.5\% + 0.05\Omega)$ No visible damage	
17	Flame retardance AEC Q200 – No.24	AEC-Q200-001 Test conditions: 9VDC to 32VDC Each 1h This test applies to rated voltages of 32V and above.	The following FAILURE CRITERIA does not occur. FAILURE CRITERIA - Electrically open a) A flame over 3.0 seconds duration b) An explosion c) A temperature above 350°C sustained for over 10 s	

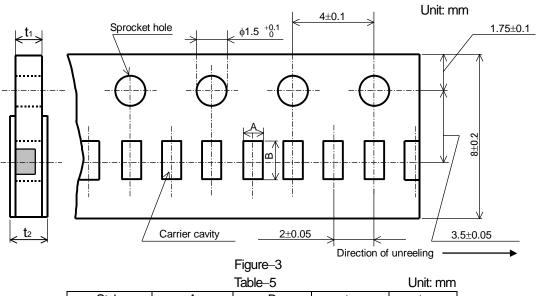
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8. Taping

- 8.1 Applicable documents JIS C 0806-3: 2014, EIAJ ET-7200C: 2010
- 8.2 Taping dimensions
- 8.2.1 Paper taping (8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-3 and Table-5.



	Unit: mm			
Style	Α	В	t 1	t ₂
RPCH10	$0.65^{+0.05}_{-0.10}$	1.15 ^{+0.05} _{-0.10}	0.4 ± 0.05	0.5max.

8.2.2 Taping dimensions shall be in accordance with Figure-4 and Table-6.

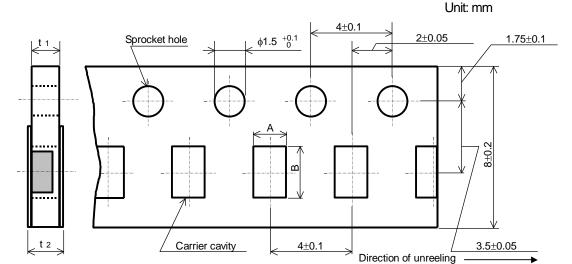


Figure-4

9						
	Unit: mm					
Style	Α	В	t 1	t 2		
RPCH16	1.15±0.15	1.9±0.2	0.6±0.1	0.8max.		
RPCH20	1.65±0.15	2.5±0.2	0.8±0.1	1.0max.		
RPCH32	2.00±0.15	3.6±0.2	0.8±0.1	1.0max.		

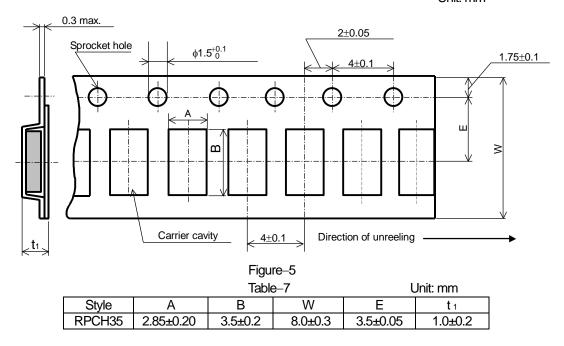
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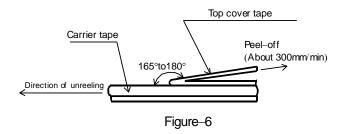
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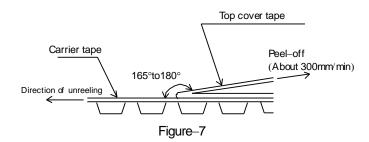
8.2.3 Embossed taping dimensions shall be in accordance with Figure-5 and Table-7.

Unit: mm



- 1). The cover tapes shall not cover the sprocket holes.
- Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following RPCH10,16,20,32:Figure–6,RPCH35:Figure-7.
- 6). When the tape is bent with the minimum radius for 25 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- In no case shall there be two or more consecutive components missing.
 The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.





Unit: mm

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8.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure–8 and Table–8.

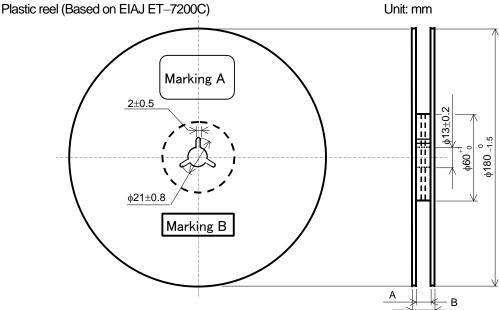
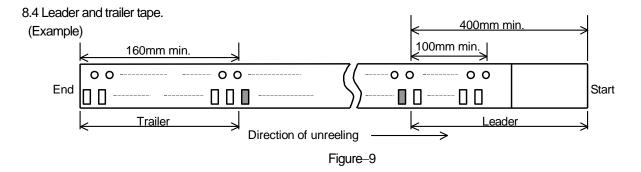


Figure-8

Table-8							
Style	Α	В	Note				
RPCH10,16,20,32,35	9 +1.0	11.4±1.0	Injection molding				
KF CI 110, 10,20,32,33		13±1.0	Vacuum forming				

Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.



9. Marking on package

The label of a minimum package shall be legibly marked with follows.

9.1 Marking A

(1) Classification

(Style, Temperature coefficient of resistance, Rated resistance, Tolerance on rated resistance, Packaging form)

- (2) Quantity (3) Lot number (4) Manufacturer's name or trade mark (5) Others
- 9.2 Marking B (KAMAYA control label)